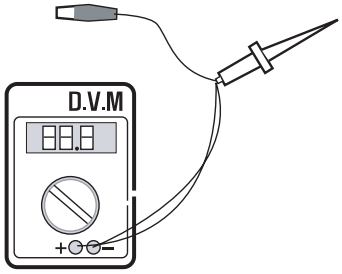
6. Reference Information

This chapter contains the tools list, list of abbreviations used in this manual, and a guide to the location space required when installing the printer. A definition of test pages and Wireless Network information definition is also included.

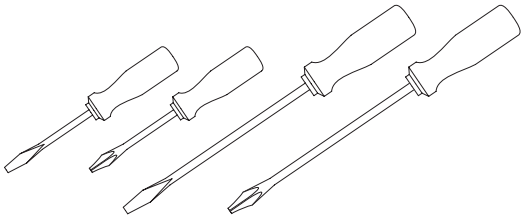
6.1 Tool for Troubleshooting

The following tools are recommended safe and easy troubleshooting as described in this service manual.

- **DVM (Digital Volt Meter)**
  Standard : Indicates more than 3 digits.



- **Driver**
  Standard : "-" type, "+" type (M3 long, M3 short, M2 long, M2 short).

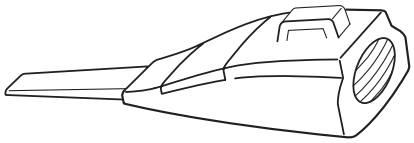


- **Tweezers**
  Standard : For general home use, small type.

- **Cotton Swab**
  Standard : For general home use, for medical service.

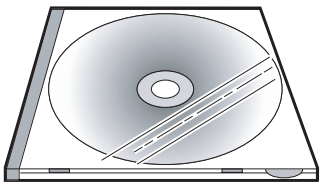
- **Cleaning Equipments**
  Standard : An IPA (Isopropyl Alcohol) dry wipe tissue or a gentle neutral detergent and lint-free cloth.

- **Vacuum Cleaner**



- **Spring Hook**
  Standard : For general use

- **Software (Driver) installation CD ROM**



6.2 Acronyms and Abbreviations

The table below explains abbreviations used in this service manual.
The contents of this service manual are declared with abbreviations in many parts. Please refer to the table.

6.2.1 Acronyms

ABS	Automatic Background Suppression(a kind of copy feature)	FDI	Foreign Device Interface
		FIA	Foreign Interface Attachment
APF	Automatic Paper Feeder(Tray)	FRU	Field Replaceable Unit
BOOTP	BOOTSTRAP PROTOCOL	FPOT	First Print Out Time
CCD	Charged Coupled Device	GW	GateWay
CIS	Contact Image Sensor	HH	High Temperature, High Humidity (Testing Chamber conditions)
CPM	Copies Per Minute		
CP	Control Panel(= OPE)	HPVC	Halftone Printing Video Controller in the SPGPm (Graphic Processor for Copy)
CQ	Copy Quality		
CRU	Customer Replaceable Unit	IDC	International Data Corp.
CRUM	CRU Memory	IMAP	Internet Message Access Protocol
CW	Center Ware	IPP	Internet Printing Protocols
CWDP	Center Ware Device Discovery Software(Samsung equivalent of Samsung's SyncThru)	IPM	Images Per Minutes
		IPX	Internetwork Packet Exchange
		IQ	Image Quality
CWIS	Center Ware Internet Services	ITU	International Telecommunication Union
DADF	Duplex Auto Document Feeder (= DADH)	JBIG	Joint Binary Image Group (a kind of image data coding method)
DC	Direct Connect	JPEG	Joint Photographic Expert Group (a kind of image data coding method)
DDNS	Dynamic Domain Name System		
DHCP	Dynamic Host Configuration Protocol	LCD	Liquid Crystal Display
DLC	Data Link Control	LEF	Long Edge Feeding
DNS	Domain Name System	LL	Low Temperature, Low Humidity (Testing Chamber conditions)
ECM	Error Correction Mode		
ECP	Enhanced Capability Port	LPR/LPD	Line Printer Daemon Protocols (LPR is a TCP-based protocol)
e-Coil	Extended Coil technology for Rapid(Fast) Fusing.		
		LSU	Laser Scanning Unit
EH&S	Samsung Environment, Health, & Safty	LUI	Local User Interface
		MCBF	Mean Copy Between Failure
ESMTP	Extended Simple Mail Transfer Protocol	MDSP	Multiple Document Single Printout
EP	Electro Photography	MFP	Multi-Functional Product
EPC	Electric Pre-Collation	MH	Modified Huffman (a kind of image data coding method)
FCOT	First Copy Out Time		

MIB	Management Information Base	RT-OS	Real Time Operating System
MIME	Multipurpose Internet Mail Extensions	RX	Receive
MR	Modified Read	S2E	Scan-To-Email
	(a kind of image data coding method)	SAD	Solid Area Density
MMR	Modified and Modified Read	SC	Service Call
	(a kind of image data coding method)	SCF	Second Cassette Feeder
MN std	Multi-National Standard	SDSP	Single Document Single Printout
MSOK	Master SOK(System Operation Key)	SDMP	Single Document Multiple Printout
MSO	Mixed Size Original	SDR	Shut Down Rate
MP	Multi Purpose	SEF	Short Edge Feeding
MPBF	Mean Print Between Failure	SIR	Sacrified(or Standard) Image Reference
MSI	Multi Sheet Input	SOK	System Operation Key
MTBF	Mean Time Between Failure	sRGB	Standard RGB
MTTR	Mean Time To Repair		(Color Coordinate System)
NCP	Network Control Protocol	SNMP	Simple Network Management Protocol
NIC	Network Interface Card	TCP/IP	Transmission Control Protocol/Internet
NOS	Network Operating System		Protocol
NN	Normal Temperature, Normal Humidity	TBC(or tbc)	To Be Confirmed
	(Testing Chamber conditions)	TBD(or tbd)	To Be Determined
NSDR	Non-Shut Down Rate(=USDR)	TIFF	(Adobe & Aldus) Tagged Image File
NW	Network		Format
OD	Optical Density	TRIM	Technical Retrofit Interim Maintenance
OHD	On Hook Dial	TTM	Time to Market
OSOK	Optional SOK(System Operation Key)	TX	Transmit
OP	Operational Procedure	UI	User Interface
PCL	Printer Control Language	UMC	Unit Manufacturing Cost
PDF	(Adobe) Portable Document Format	UMR	Unscheduled Maintenance Ratio
PPM	Pages Per Minutes	UPnP	Universal Plug and Play
PQ	Print Quality	USB	Universal Serial Bus
PS/3	PostScript Level-3	USDR	Un-Shut Down Rate(=NSDR)
PVC	Printing Video Controller in the	XCMI	Samsung's Management Information
	SPGPm(Graphic Processor for Printer)		Base
QCD	Quality, Cost, and Delivery	WA	Warranty Action
RCP	Remote Control Panel	W x D x H	Width x Depth x Height

6.2.2 Service Parts

ACRONYM	EXPLANATION
ELA HOU-SCANNER ASS'Y	ELA=Electrical Assembly, HOU =Housing
MEA UNIT-COVER PA EXIT ASS'Y	MEA= Mechanical Assembly, PA=Paper
PMO-TRAY EXTENTION MP NE	PMO= Processing Mold MP=Multi-Purpose(Bypass) tray NE=for NEC (common as Samsung Halk printer)
MEC-CASSETTE ASS'Y(LETTER)	MEC = Mechanic Combined unit
COVER-M-FRONT	M=Mold
MPR-NAME/PLATE	MPR= Machinery Press,
UNIT-LSU	LSU =Laser Scanning Unit
SMPS-SMPS(V1)+HVPS	SMPS =Switching Mode Power Supply HVPS =High Voltage Power Supply
ELA-OPC UNIT SET	OPC=Organic Photo-Conductive
ELA HOU-MP ASS'Y	MP =Multi-Purpose (Bypass) tray
PBA MAIN-MAIN	PBA =Printed circuit Board Assembly
PMO-CONNECT PAPER MFP	MFP =Multi-Functional Peripheral
FAN-DC	DC =Direct Current
CBF POWER STITCH GRAY	CBF= Cable Form
MEA UNIT GUIDE CST PA ASS'Y	CST=Cassette(Paper tray), PA=Paper
PBA LIU	PBA =Printed circuit Board Assembly LIU =Line Interface Unit for FAX
SHIELD-P_MAIN LOWER	P=Press
CBF HARNESS-LIU GND	LIU =Line Interface Unit for FAX GND= Ground
PMO-COVER FEED AY	AY=Assembly
PMO-COVER BRKT MOTER	BRKT=Bracket
CBF HARNESS-LSU	LSU =Laser Scanning Unit
IPR-SHIELD SMPS UPPERI	IPR=Iron Press
PMO-BUSHING P/U.MP	P/U=Pickup MP=Multi-Purpose (Bypass) Tray
PMO-HOLDER GEAR TRr	TR= Transfer Roller
SPRING ETC-TR_L	TR_L=Transfer Roller - Left
PMO-CAM JAM REMOVE	PMO-CAM= Processing Mold-CAM
PMO-LOCKER DEVE	DEVE=Developer

ACRONYM	EXPLANATION
SPECIAL SCREW(PANNEL MFP)	MFP =Multi-Functional Peripheral
A/S MATERAL-DUMMY UPPER ASS'Y	A/S=After-Service
MCT-GLASS ADF	MCT= Machinery Cutting ADF=Automatic Document Feeder
PPR-REGISTRATION EDGE(F)	PPR= Processing Press
IPR-HOLDER GLASSI	PR=Iron Press
MCT-GLASS SCANNER(LEGAL)	MCT= Machinery Cutting
CBF HARNESS-OPE	OPE=Operation Panel(Control Panel)
PBA SUB-D_SUB	PBA SUB-D_SUB =>Sub Printed circuit Board Assembly for the D-SUB type electrical connector (D-Sub) a kind of the connector type(shape 'D')
COVER-M-CCD CABLE	M=Mold CCD=Charge Coupled Device
COVER-SCAN LOWER(UMAX)	UMAX=> Supplier's name for CCD module
ICT-INSERT SHAFTI	ICT= Iron Cutting
IPR-BRK SCAN BD	IPR=Iron Press BRK=Bracket BD= Board
CBF SIGNAL-CCD FFC	CCD = Charge Coupled Device FFC =Flexible Flat Cable
COVER-M-OPE	M=Mold OPE=Operation Panel(Control Panel)
KEY-M-COPY	M=Mold
PLATE-M-ALPHA KEY	M=Molde ALPHA=Alphabet
PMO-GUIDE DP SIDE	DP=Duplex
RING-CS	CS= Compress
GEAR-MP/DUP DRV	MP =Multi-Purpose (Bypass) tray DUP DRV = Duplex Driver
IPR-BRKT G DUPI	PR=Iron Press BRKT=BRACKET G= Ground UP=Duplex
PMO-BUSHING TX(B4)	TX=Transmit
PMO-TRAY CASE, MP	MP=Multi-Purpose tray(Bypass tray)

ACRONYM	EXPLANATION
SPRING CS RE	CS=Compress RE=Rear
SPRING CS FR	CS=Compress FR=Front
PMO-BUSHING FINGER, F	F=Front
ICT-SHAFT-EXIT LOWER ID	ID=Idler
SPRING-EXIT ROLL FD	FD=Face Down
PMO-BUSHING_P/U,MP	P/U=Pickup MP =Multi-Purpose (Bypass) tray
PMO-HOLDER CAM MPF	MPF=Multi-Purpose Feeder(=MP)
PMO-GEAR P/U MPF	P/U=Pickup
MFP =Multi-Functional Peripheral	
RPR-RUBBER PICK UP,MP	RPR=Rubber Press
PBA SUB-MP SEN	PBA SUB-MP-SEN =>Sub Printed circuit Board Assembly for the MP-SEN(= Multi-Purpose (Bypass) tray-Sensor)
A/S MATERAL-PICKUP,MP	
FOOT-ML80	
HOLDER CATCH CST MC2	MC2=>McKInley2 (Samsung Project code name)
IPR-GROUND PLATE A(OPC)	OPC=Organic Photo-Conductive
ELA M/M-AUD SPEAKER	ELA M/M => Electrical Assembly M/M AUD=Audio
CBF HARNESS-OPC GND	OPC GNG=Organic Photo-Conductive-Ground
IPR-GROUND PLATE SCF	SCF=Second Cassette Feeder(Tray2)
PBA SUB-PTL	PBA SUB-PTL=>Sub Printed circuit Board Assembly for the PTL(= Pre Transfer Lamp)
PBA SUB-FEED+P.EMP SEN.	PBA SUB-FEED=>Sub Printed circuit Board Assembly for the feeder EMP SEN=Empty Sensor
MOTOR STEP-MCK2(MAIN)	
GEAR-EXIT/U	EXIT/U=EXIT/Upper
GEAR-RDCN FEED INNER	RDCN=Reduction
CBF-HARNESS-MAIN-THV WIRE	THV =Transfer High Voltage
CBF-HARNESS-MAIN-MHV WIRE	MHV= High Voltage(Charge Voltage)

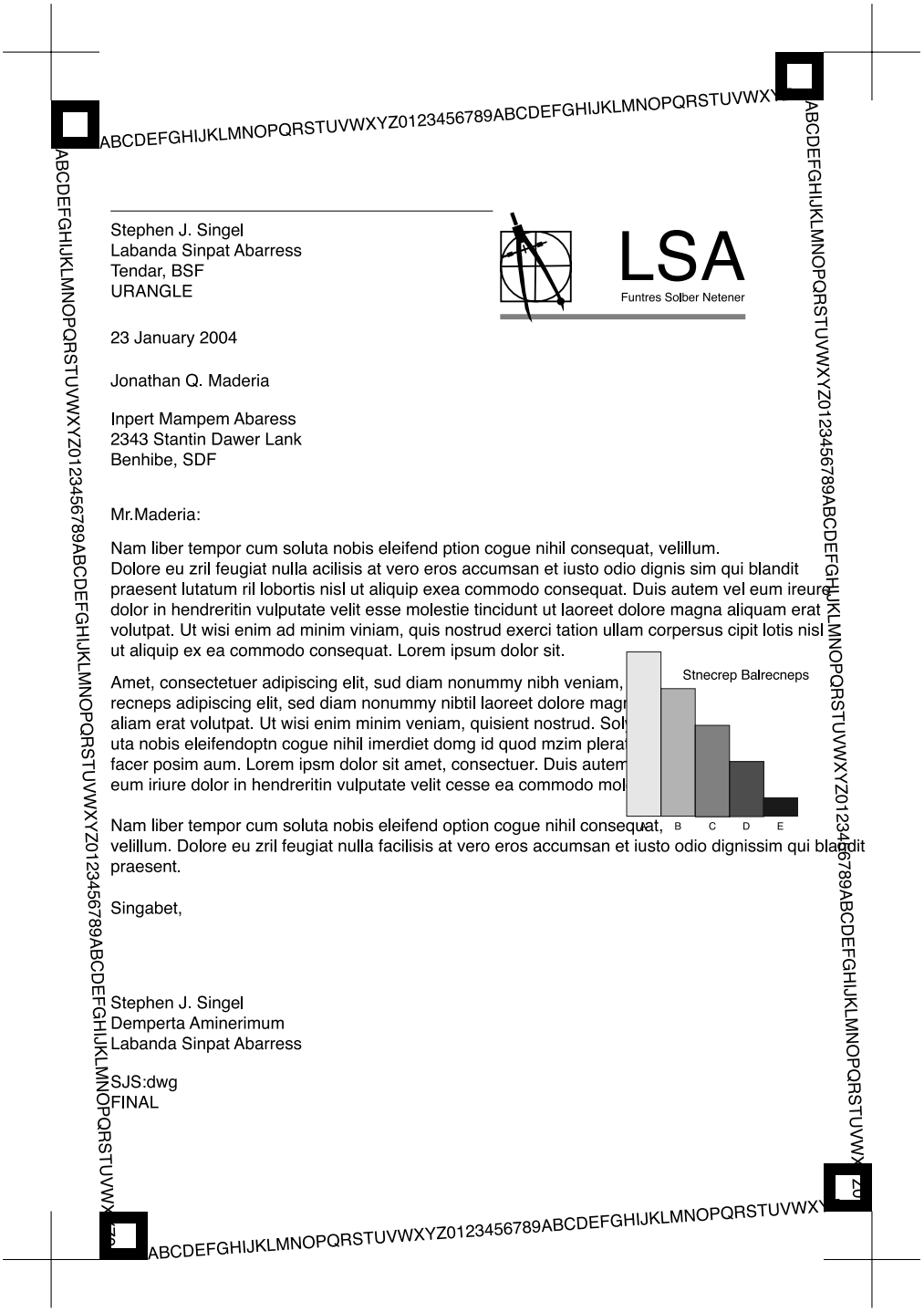
ACRONYM	EXPLANATION
GEAR-EXIT/U,ID	U=Upper ID=Idler
IPR-TERMINAL FU	FU=Fuser
PMO-BEARING H/R-F	H/R-F=Heat Roller - Front
BEARING-H/R L	H/R-L=Heat Roller -Left
PEX-ROLLER EXIT F_UP	PEX= Processing Extrude F_UP=Face Up
SPRING ETC-P/R	P/R=Pressure Roller
SPRING(R)-CAU-HOT-FU	CAU-HOT-FU = Caution Hot -Fuser
PMO-ARM ACTUATOR	PMO-ARM= Processing Mold Arm
LABEL(R)-HV FUSER	HV=High Voltage (220V)
LABEL(R)-LV FUSER	LV=Low Voltage (110V)
PPR-SPONG SHEET	PPR=Plastic Press
IPR-P_PINCH(SCAN)I	PR-P = Iron Press
ROLLER-REGI	REGI=Registration
PBA SUB-REGI	PBA SUB-REGI => Sub Printed circuit Board Assembly for the Registration
GROUND-P_SCAN ROLLER	GROUND-P =Ground-Press
IPR-GUARD C/O S/W	C/O = Cover Open S/W= Switch
MEA UNIT-TX STACKER	TX =Transmit
IPR-WASHER SPRING CU	CU=Curve

6.3 The Sample Pattern for the Test

The sample pattern shown in below is the standard pattern used in the factory.
The life of the toner cartridge and the printing speed are measured using the pattern shown below.
(The image is 70% of the actual A4 size).

6.3.1 A4 ISO 19752 Standard Pattern

This test page is reproduced at 70% of the normal A4 size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FINAL

6.4 Selecting a location

Select a level, stable place with adequate space for air circulation. Allow extra space for opening covers and trays.
The area should be well-ventilated and away from direct sunlight or sources of heat, cold, and humidity. Do not set the machine close to the edge of your desk or table.

Clearance space

- Front: 482.6 mm (enough space so that the paper tray can be removed)
- Back: 180 mm (enough space for ventilation)
- Right: 100 mm (enough space for ventilation)
- Left: 100 mm (enough space for ventilation)